

# MG001AL030060A

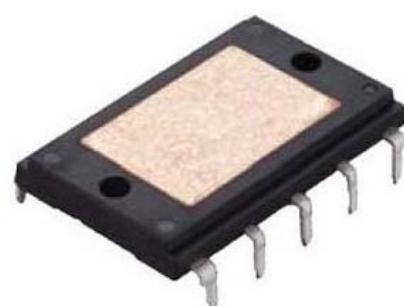
Converter - Brake Module

## Feature

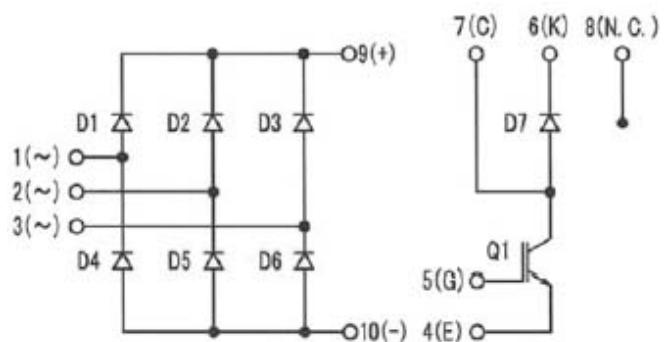
- Small DIP
- Isolated package
- High Voltage
- UL E142422
- Halogen free
- Pb free terminal
- RoHS:Yes

## Outline

House Name: MG001



## Equivalent circuit



●絶対最大定格 Absolute maximum ratings (指定のない場合は、 $T_c = 25^\circ\text{C}$  / Unless otherwise specified  $T_c = 25^\circ\text{C}$ . )

コンバータ部 / Converter

ダイオード / Diode

項目 Item	記号 Symbol	条件 Conditions	規格値 Ratings	単位 Unit
接合部温度 Junction temperature	$T_j$		150	°C
ピーケ繰返し逆電圧 Repetitive peak reverse voltage	$V_{RRM}$		600	V
ピーケ非繰返し逆電圧 Non-repetitive peak reverse voltage	$V_{RSM}$		800	V
平均順電流 Average forward current	$I_{F(AV)}$	50Hz, 正弦波, 抵抗負荷, $T_c=136^\circ\text{C}$ 50Hz, Sine wave, Resistance load, $T_c=136^\circ\text{C}$	30	A
サージ順電流 Surge forward current	$I_{FSM}$	50Hz, 正弦波, 非繰返し, 1サイクル, せん頭値, 1素子当り, $T_j=25^\circ\text{C}$ 50Hz, Sine wave, Not-repetitive, 1cycle, Peak value, Per diode, $T_j=25^\circ\text{C}$	300	A
	$I_{FSM1}$	$tp=1\text{ms}$ , 正弦波, 非繰返し, せん頭値, 1素子当り, $T_j=25^\circ\text{C}$ $tp=1\text{ms}$ , Sine wave, Not-repetitive, Peak value, Per diode, $T_j=25^\circ\text{C}$	700	A
電流二乗時間積 Current squared time	$I^2_t$	1ms $\leq t < 10\text{ms}$ , 1素子当り, $T_j=25^\circ\text{C}$ 1ms $\leq t < 10\text{ms}$ , Per diode, $T_j=25^\circ\text{C}$	300	A <sup>2</sup> s

最大瞬間接合部温度は150°C(at  $T_c \leq 136^\circ\text{C}$ )ですが、安全動作させるための平均動作接合部温度は $T_j \leq 125^\circ\text{C}$ (at  $T_c \leq 111^\circ\text{C}$ )でご使用ください。

The maximum rated temperature of the is 150°C(at  $T_c \leq 136^\circ\text{C}$ )

, but in order to operate safely, please use the average operating temperature  $T_j \leq 125^\circ\text{C}$ (at  $T_c \leq 111^\circ\text{C}$ ).

ブレーキ部 / Brake

IGBT

項目 Item	記号 Symbol	条件 Conditions	規格値 Ratings	単位 Unit
チャネル温度 Channel temperature	$T_{ch}$		150	°C
コレクタ-エミッタ間電圧 Collector-emitter voltage	$V_{CES}$		600	V
ゲート-エミッタ間電圧 Gate-emitter voltage	$V_{GES}$		$\pm 20$	V
コレクタ電流 (直流) Continuous collector current (DC)	$I_C$		30	A
コレクタ電流 (ピーケ) Continuous collector current (Peak)	$I_{CP}$	パルス幅 10μs, Duty = 1/100 Pulse width 10μs, Duty = 1/100	60	A
全損失 Total power dissipation	$P_T$		125	W

## ブレーキ部 / Brake

## ダイオード / Diode

項目 Item	記号 Symbol	条件 Conditions	規格値 Ratings	単位 Unit
接合部温度 Junction temperature	T <sub>j</sub>		150	°C
ピーク繰返し逆電圧 Repetitive peak reverse voltage	V <sub>RRM</sub>		600	V
平均順電流 Average forward current	I <sub>F(AV)</sub>	50Hz, 正弦波, 抵抗負荷, T <sub>c</sub> =137°C 50Hz, Sine wave, Resistance load, T <sub>c</sub> =137°C	3.0	A
サージ順電流 Surge forward current	I <sub>FSM</sub>	50Hz, 正弦波, 非繰返し, 1サイクル, せん頭値, T <sub>j</sub> =25°C 50Hz, Sine wave, Not-repetitive, 1cycle, Peak value, T <sub>j</sub> =25°C	90	A
	I <sub>FSM1</sub>	tp=1ms, 正弦波, 非繰返し, せん頭値, T <sub>j</sub> =25°C tp=1ms, Sine wave, Not-repetitive, Peak value, T <sub>j</sub> =25°C	210	A
電流二乗時間積 Current squared time	I <sup>2</sup> <sub>t</sub>	1ms≤tp<10ms, T <sub>j</sub> =25°C 1ms≤tp<10ms, T <sub>j</sub> =25°C	28	A <sup>2</sup> s

最大瞬間接合部温度は150°C(at T<sub>c</sub>≤137°C)ですが、安全動作させるための平均動作接合部温度はT<sub>j</sub>≤125°C(at T<sub>c</sub>≤112°C)でご使用ください。

The maximum rated temperature of the is 150°C(at T<sub>c</sub>≤137°C)

, but in order to operate safely, please use the average operating temperature T<sub>j</sub>≤125°C(at T<sub>c</sub>≤112°C).

## モジュール共通 / Module

項目 Item	記号 Symbol	条件 Conditions	規格値 Ratings	単位 Unit
保存温度 Storage temperature	T <sub>stg</sub>		-40~125	°C
絶縁耐圧 Dielectric strength	V <sub>dis</sub>	一括端子・ケース間, AC1分間印加 Terminals to case, AC 1minute	2.5	kV
締め付けトルク Mounting Torque	TOR	主端子・取付用(推奨値 : 0.8N·m) main terminal fitting part (Recommended Torque : 0.8N·m)	1.5	N·m

●電気的・熱的特性 Electrical and thermal characteristics (指定のない場合は、T<sub>c</sub> = 25°C / Unless otherwise specified T<sub>c</sub> = 25°C.)

## コンバータ部 / Converter

## ダイオード / Diode

項目 Item	記号 Symbol	条件 Conditions	規格値 Ratings			単位 Unit
			Min.	Typ.	Max.	
順電圧 Forward voltage	V <sub>F</sub>	I <sub>F</sub> =10A, パルス測定, 1素子当たり I <sub>F</sub> =10A, Pulse measurement, Per diode	-	-	1.05	V
逆電流 Reverse current	I <sub>R</sub>	V <sub>R</sub> =600V, パルス測定, 1素子当たり V <sub>R</sub> =600V, Pulse measurement, Per diode	-	-	10	μA

## ブレーキ部 / Brake

IGBT

項目 Item	記号 Symbol	条件 Conditions	規格値 Ratings			単位 Unit
			Min.	Typ.	Max.	
コレクタ-エミッタ間降伏電圧 Collector-emitter breakdown voltage	$V_{(BR)CES}$	$I_C=1\text{mA}, V_{GE}=0\text{V}$	600	-	-	V
コレクタ遮断電流 Zero gate voltage collector current	$I_{CES}$	$V_{CE}=600\text{V}, V_{GE}=0\text{V}$	-	-	10	$\mu\text{A}$
ゲート漏れ電流 Gate-emitter leakage current	$I_{GES}$	$V_{GE}=\pm20\text{V}, V_{CE}=0\text{V}$	-	-	$\pm1$	$\mu\text{A}$
コレクタ・エミッタ間オン電圧 Static collector-emitter saturation voltage	$V_{CE(\text{sat})}$	$I_C=30\text{A}, V_{GE}=15\text{V}$	-	1.5	2.0	V
ゲートしきい値電圧 Gate threshold voltage	$V_{TH}$	$I_C=1\text{mA}, V_{CE}=10\text{V}$	4.5	6.0	7.5	V
ゲート全電荷量 Total gate charge	$Q_g$	$V_{CC}=400\text{V}, V_{GE}=15\text{V}, I_C=30\text{A}$	-	95	-	nC
ゲート-エミッタ電荷量 Gate to emitter charge	$Q_{ge}$		-	28	-	
ゲート-コレクタ電荷量 Gate to collector charge	$Q_{gc}$		-	39	-	
入力容量 Input capacitance	$C_{ies}$	$V_{CE}=25\text{V}, V_{GE}=0\text{V}, f=1\text{MHz}$	-	3290	-	pF
帰還容量 Reverse transfer capacitance	$C_{res}$		-	56	-	
出力容量 Output capacitance	$C_{oes}$		-	108	-	
ターンオン遅延時間 Turn-on delay time	$td(\text{on})$	$I_C=30\text{A}, V_{CC}=300\text{V}, L=100\mu\text{H}, V_{GS(+)}=15\text{V}, V_{GS(-)}=-15\text{V}, R_G=50\Omega$	-	147	-	ns
上昇時間 Rise time	$tr$		-	103	-	
ターンオフ遅延時間 Turn-off delay time	$td(\text{off})$		-	205	-	
下降時間 Fall time	$tf$		-	182	-	

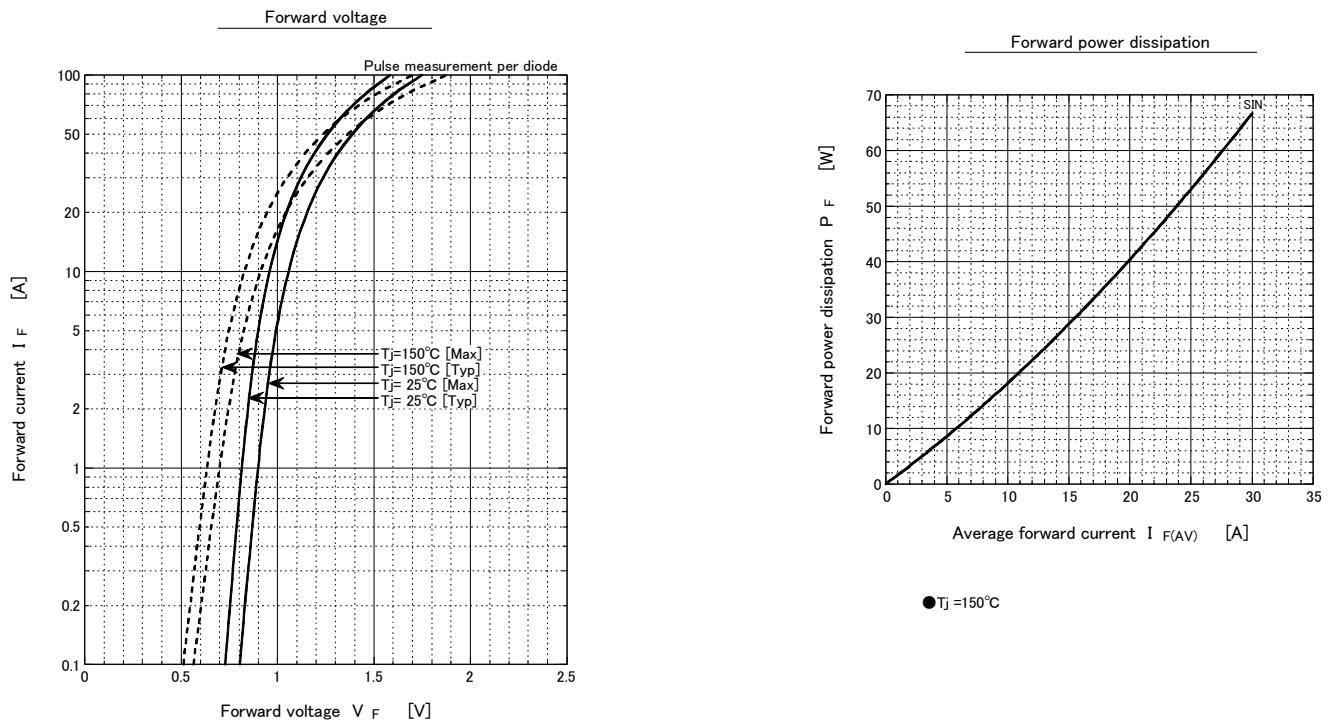
## ブレーキ部 / Brake

## ダイオード / Diode

項目 Item	記号 Symbol	条件 Conditions	規格値 Ratings			単位 Unit
			Min.	Typ.	Max.	
順電圧 Forward voltage	$V_F$	$I_F=3A$ , パルス測定 $I_F=3A$ , Pulse measurement	—	—	1.65	V
逆電流 Reverse current	$I_R$	$VR=600V$ , パルス測定 $VR=600V$ , Pulse measurement	—	—	10	$\mu A$
逆回復時間 Reverse recovery time	$t_{rr}$	$I_F=0.5A$ , $I_R=1.0A$ , $0.25I_R$	—	—	50	ns

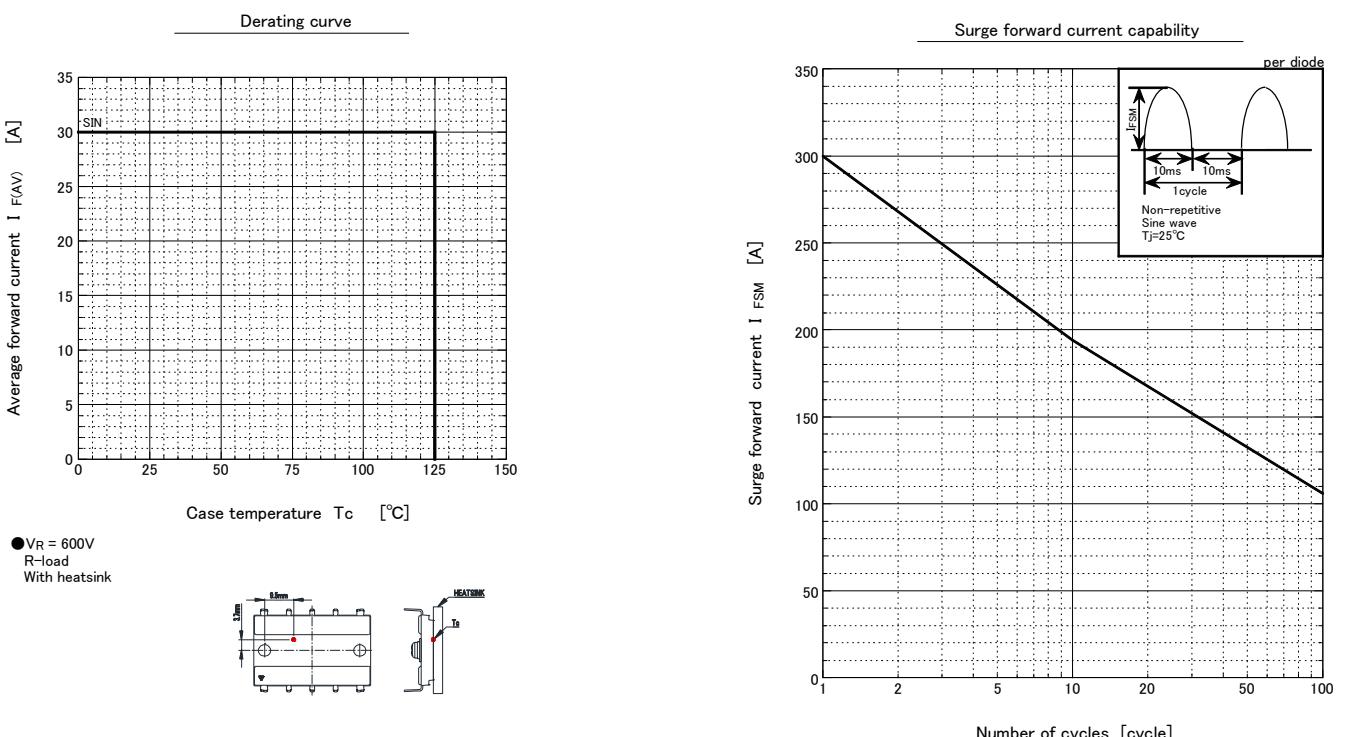
モジュール共通 / Module

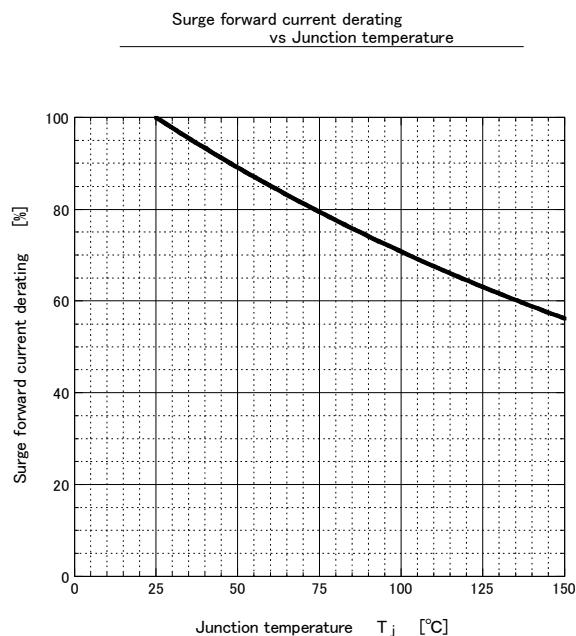
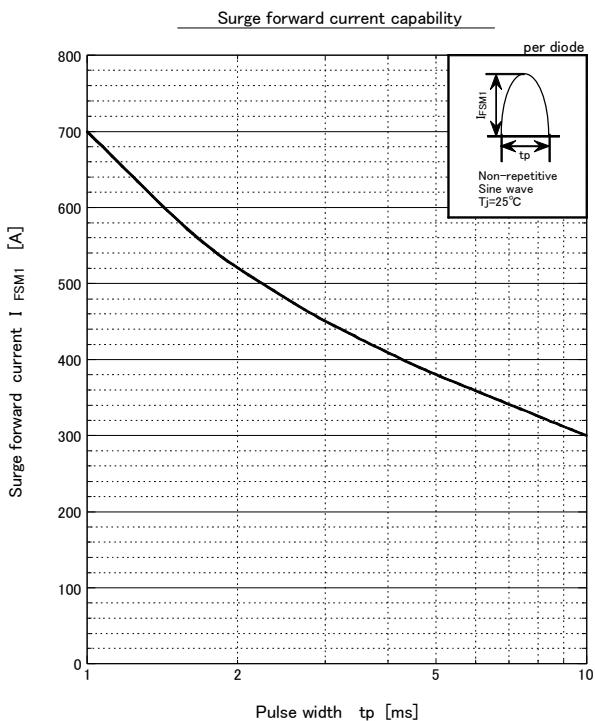
項目 Item	記号 Symbol	条件 Conditions	規格値 Ratings			単位 Unit	
			Min.	Typ.	Max.		
熱抵抗 Thermal resistance	$R_{th(j-c)}$	接合部・ケース間 Junction to case	コンバータ部 Converter	モジュールあたり(合計) Per Module (Total)	–	0.2	°C/W
			ブレーキ部 Brake	1素子あたり Per IGBT	–	1.0	
				1素子あたり Per Diode	–	2.4	



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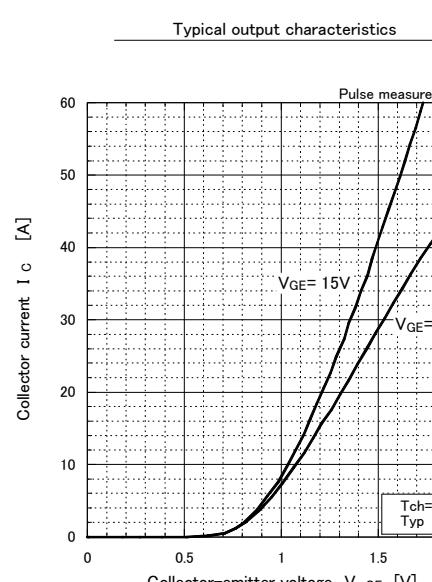
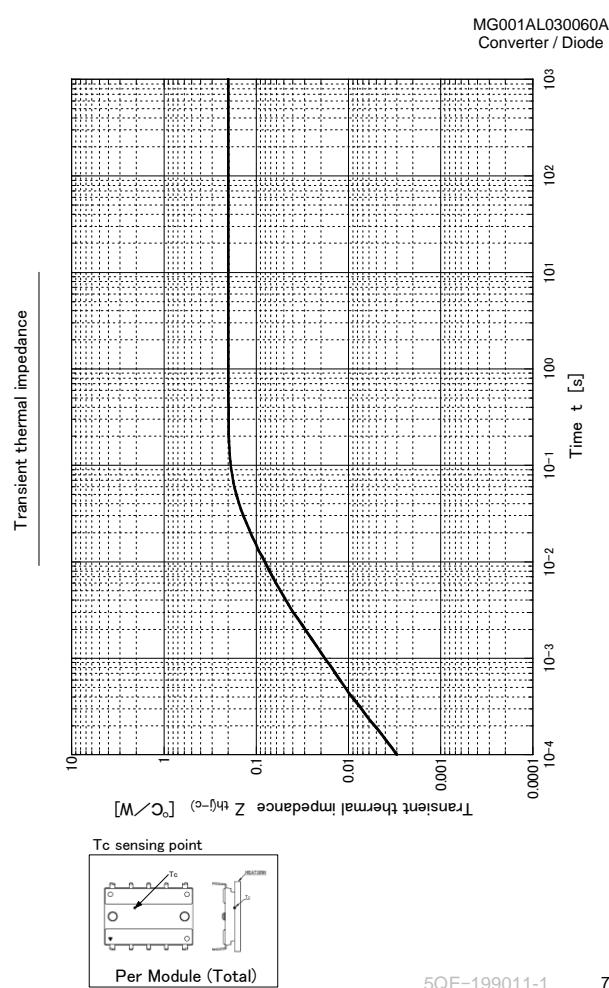
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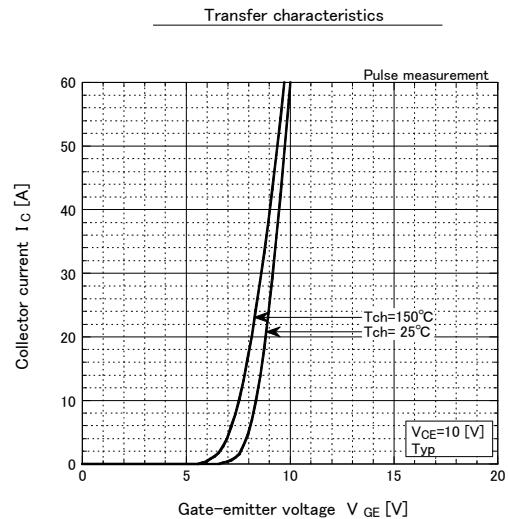
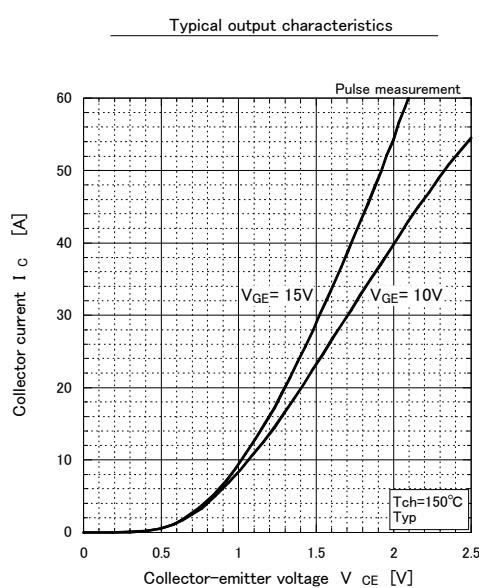
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Note: The above characteristics curves are presented for reference only and not guaranteed by production test unless otherwise noted.

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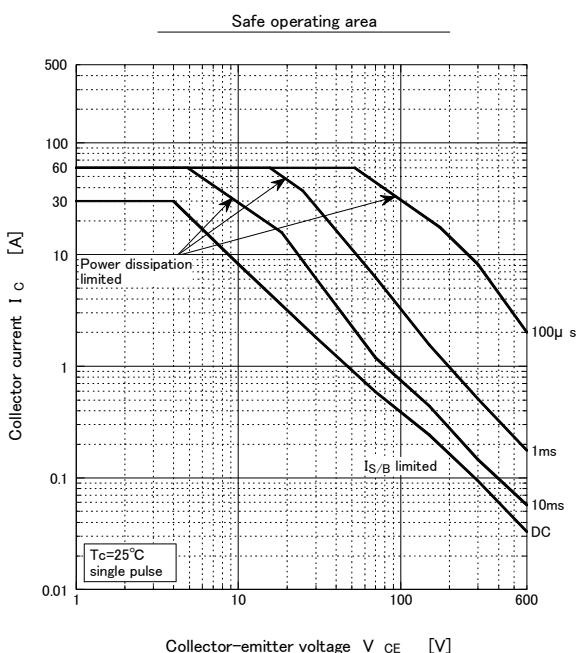
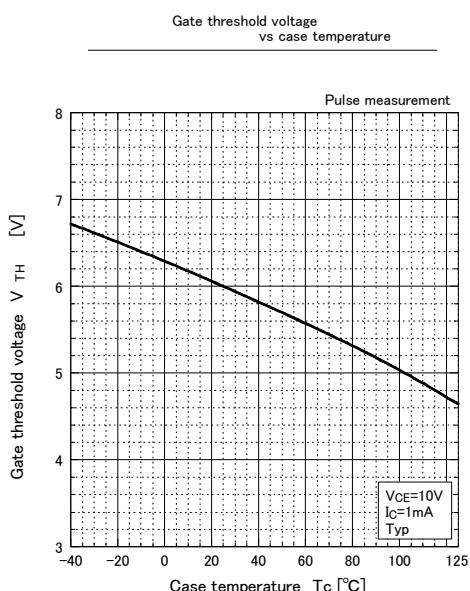


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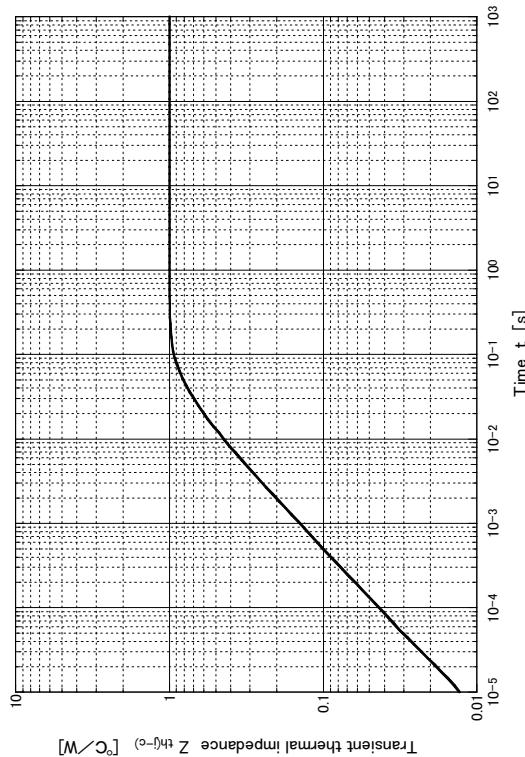


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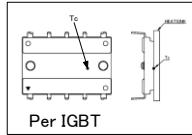
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Transient thermal impedance

Transient thermal impedance  $Z_{th(j-G)}$  [ $^{\circ}\text{C}/\text{W}$ ]

Tc sensing point

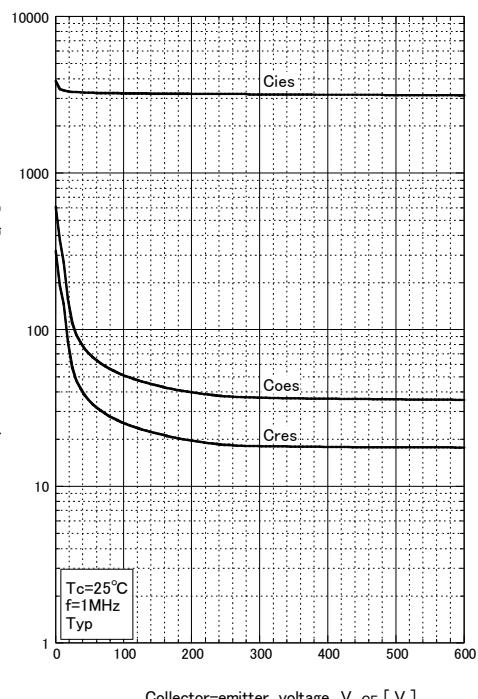


Per IGBT

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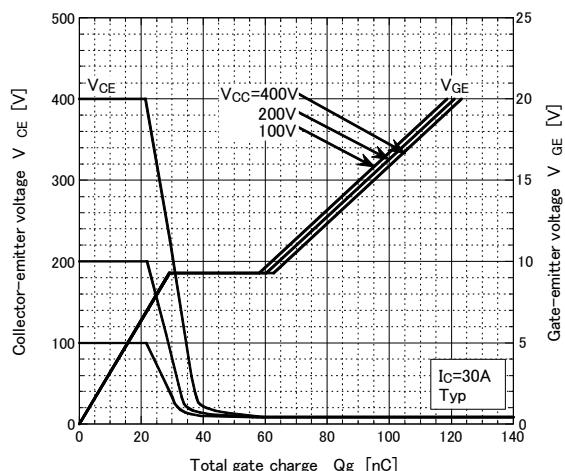
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## Capacitance characteristics

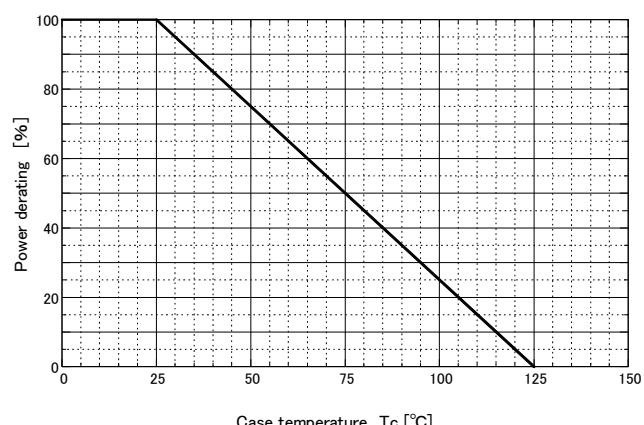
Collector-emitter voltage  $V_{CE}$  [V]

Note: The above characteristics curves are presented for reference only and not guaranteed by production test,unless otherwise noted.

## Gate charge characteristics

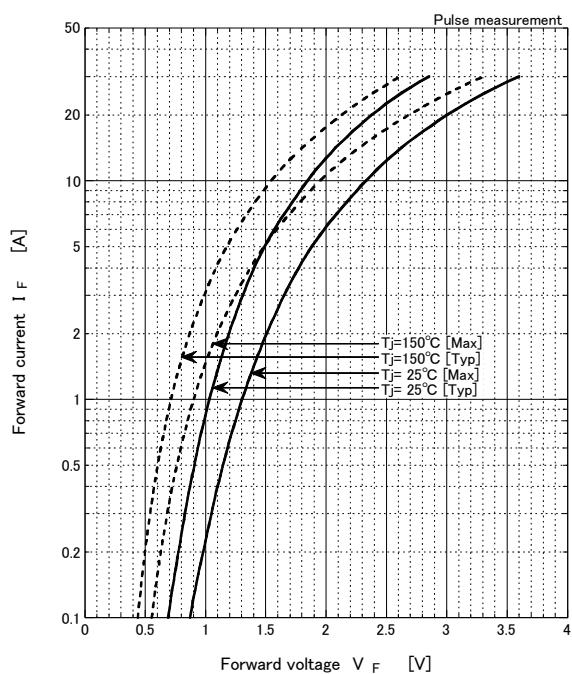
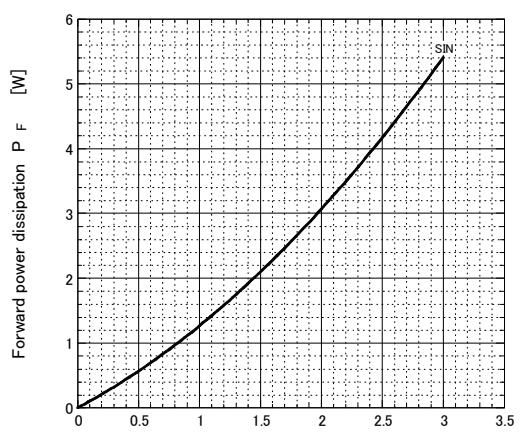


## Power derating – case temperature



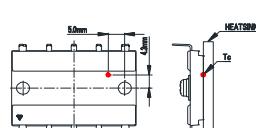
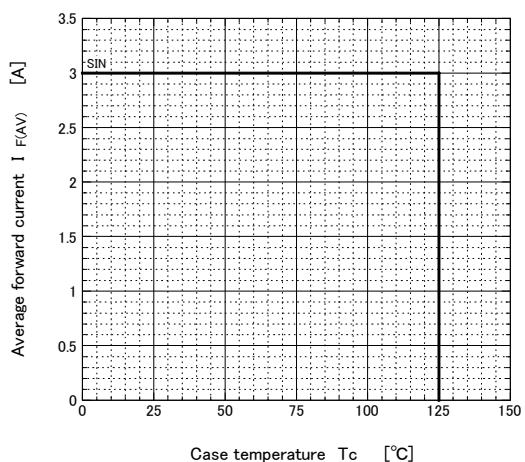
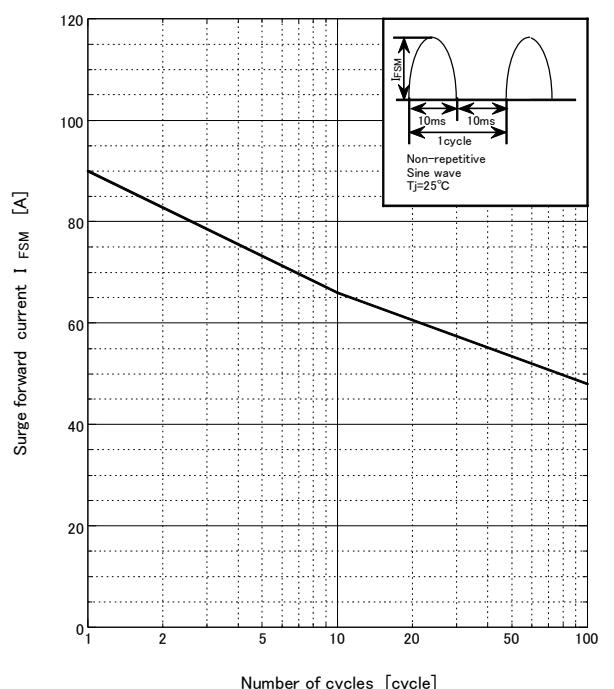
Note: The above characteristics curves are presented for reference only and not guaranteed by production test,unless otherwise noted.

Note: MOS FET characteristics

Forward voltageForward power dissipation

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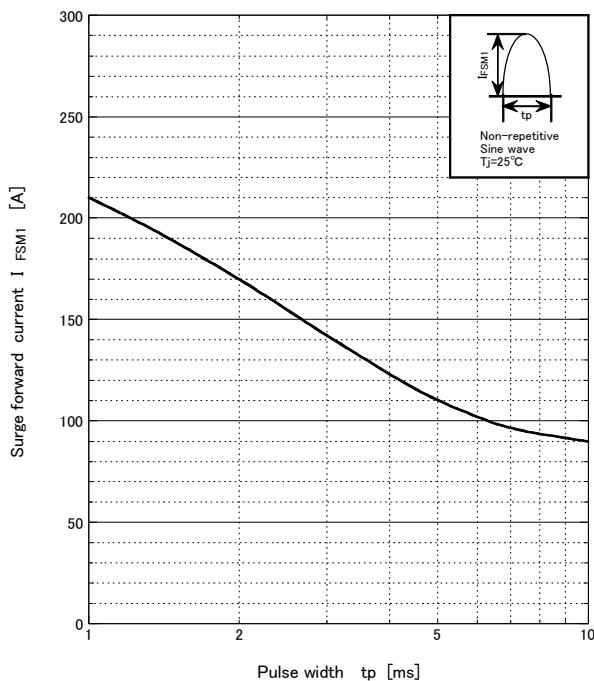
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Derating curveSurge forward current capability

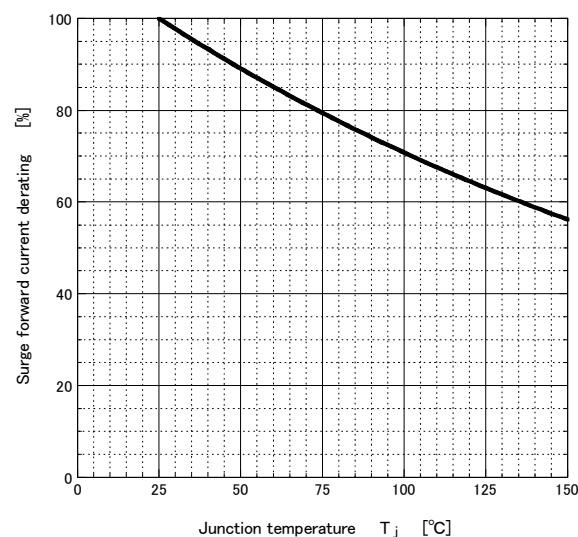
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Surge forward current capability



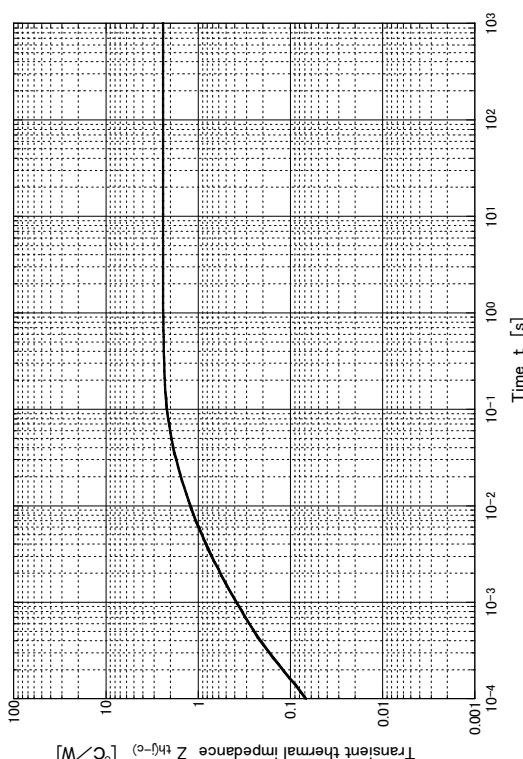
Surge forward current derating vs Junction temperature



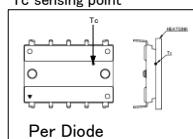
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Transient thermal impedance



T<sub>c</sub> sensing point



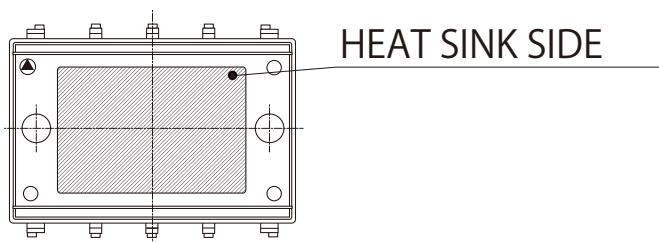
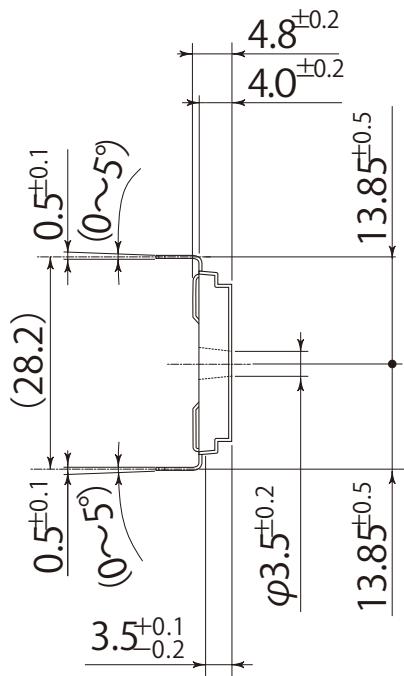
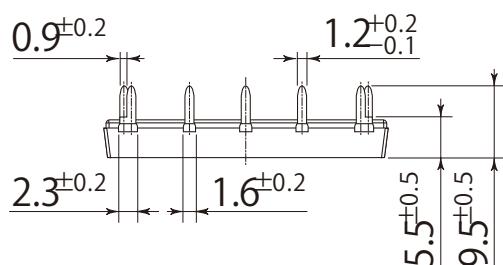
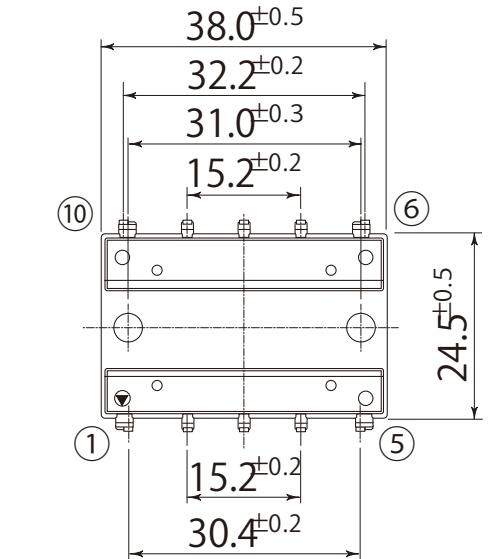
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# Package Outline-Dimensions

unit : mm  
scale: 1/1

F4

JEDEC Code	-
JEITA Code	-
House Name	MG001



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U182(2019.02)

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